

Single N-Channel, 20V, 1.85A, Power MOSFET

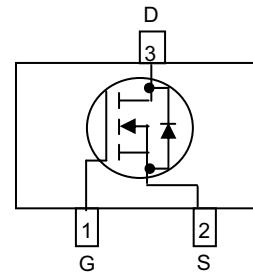
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
20	0.072@ $V_{GS}=4.5V$	1.8
	0.088@ $V_{GS}=2.5V$	1.5
	0.115@ $V_{GS}=1.8V$	1.0



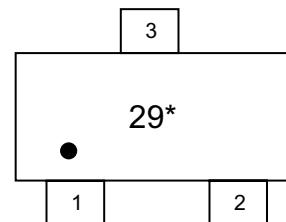
Descriptions

The WNM2029 is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WNM2029 is Pb-free.

SOT-323



Pin configuration (Top view)



29 = Device Code
* = Month (A~Z)

Marking

Applications

- Driver for Relay, Solenoid, Motor, LED etc.
- DC-DC converter circuit
- Power Switch
- Load Switch
- Charging

Order information

Device	Package	Shipping
WNM2029-3/TR	SOT-323	3000/Reel&Tape

**Absolute Maximum ratings**

Parameter	Symbol	10 S	Steady State	Unit
Drain-Source Voltage	V _{DS}	20		V
Gate-Source Voltage	V _{GS}	±12		
Continuous Drain Current ^a	T _A =25°C	I _D	1.85	1.69
	T _A =70°C		1.48	1.35
Maximum Power Dissipation ^a	T _A =25°C	P _D	0.36	0.3
	T _A =70°C		0.23	0.19
Continuous Drain Current ^b	T _A =25°C	I _D	1.65	1.51
	T _A =70°C		1.32	1.21
Maximum Power Dissipation ^b	T _A =25°C	P _D	0.28	0.24
	T _A =70°C		0.18	0.15
Pulsed Drain Current ^c	I _{DM}		8	A
Operating Junction Temperature	T _J		150	°C
Lead Temperature	T _L		260	°C
Storage Temperature Range	T _{stg}		-55 to 150	°C

Thermal resistance ratings

Parameter	Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance ^a	t ≤ 10 s	R _{θJA}	290	345
	Steady State		335	415
Junction-to-Ambient Thermal Resistance ^b	t ≤ 10 s	R _{θJA}	380	435
	Steady State		450	520
Junction-to-Case Thermal Resistance	R _{θJC}	270	310	°C/W

a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

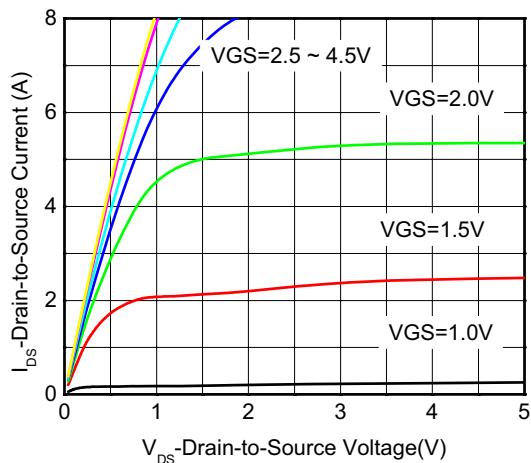
b Surface mounted on FR4 board using minimum pad size, 1oz copper

c Repetitive rating, pulse width limited by junction temperature, t_p=10μs, Duty Cycle=1%d Repetitive rating, pulse width limited by junction temperature T_J=150°C.

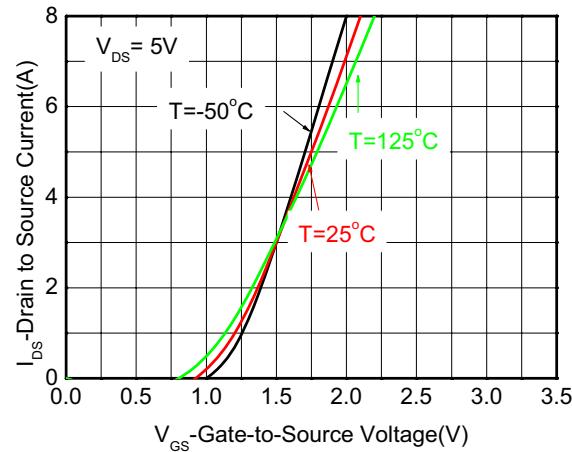


Electronics Characteristics (Ta=25°C, unless otherwise noted)

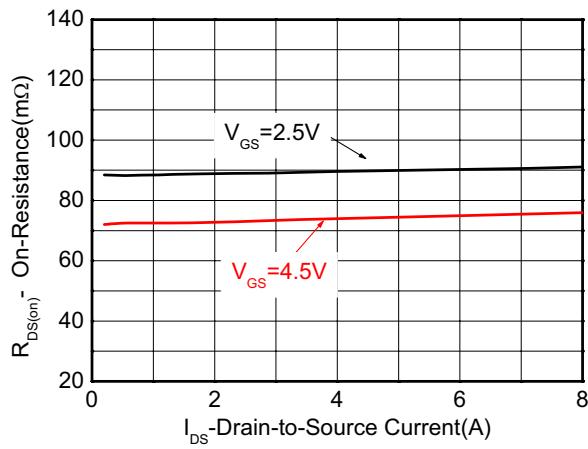
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0 V, I _D = 250uA	20.5			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 16 V, V _{GS} = 0V			100	nA
Gate-to-source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±12V			100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250uA	0.50	0.65	0.80	V
Drain-to-source On-resistance	R _{DS(on)}	V _{GS} = 4.5V, ID = 1.8A		72	87	mΩ
		V _{GS} = 2.5V, ID = 1.5A		88	105	
		V _{GS} = 1.8V, ID = 1.0A		115	138	
Forward Transconductance	g _{FS}	V _{DS} = 5 V, ID = 1.8A		6		S
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 10 V		185		pF
Output Capacitance	C _{OSS}			58		
Reverse Transfer Capacitance	C _{RSS}			54		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 10 V, I _D = 1.8A		4.1		nC
Threshold Gate Charge	Q _{G(TH)}			0.2		
Gate-to-Source Charge	Q _{GS}			0.6		
Gate-to-Drain Charge	Q _{GD}			1.25		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	td(ON)	V _{GS} = 4.5 V, V _{DS} = 6 V, R _L =3 Ω, R _G =6 Ω		9.0		ns
Rise Time	tr			14.0		
Turn-Off Delay Time	td(OFF)			25.0		
Fall Time	tf			9.0		
BODY DIODE CHARACTERISTICS						
Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = 1.0A	0.5	0.7	1.0	V

Typical Characteristics (Ta=25°C, unless otherwise noted)


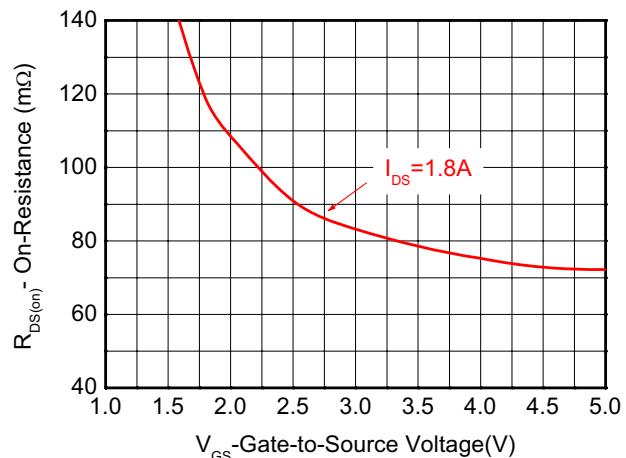
Output characteristics



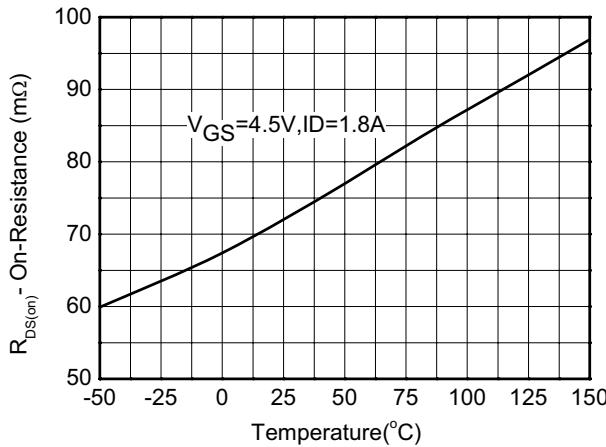
Transfer characteristics



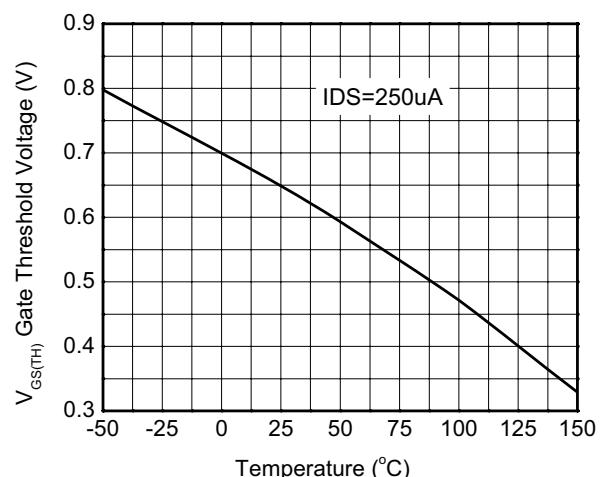
On-Resistance vs. Drain current



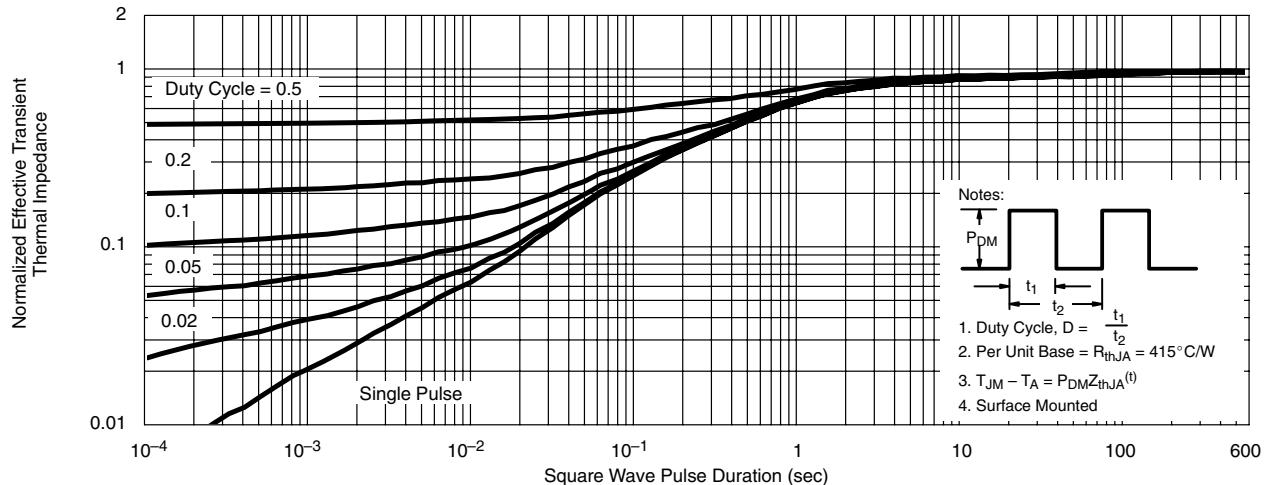
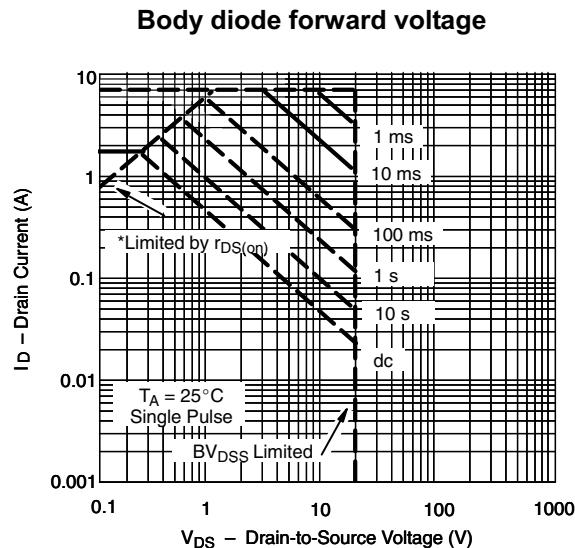
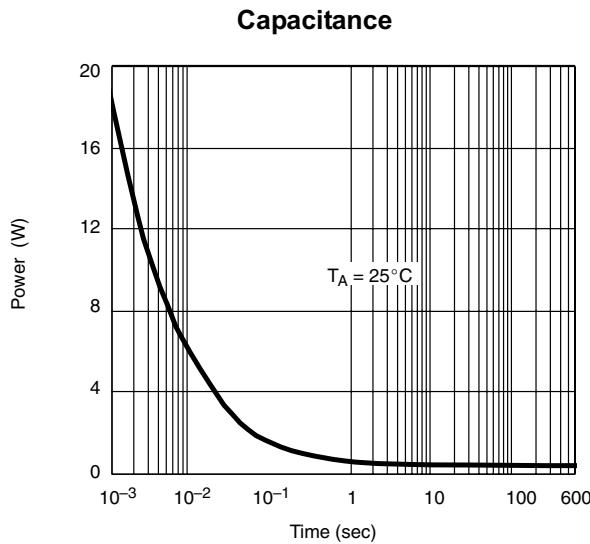
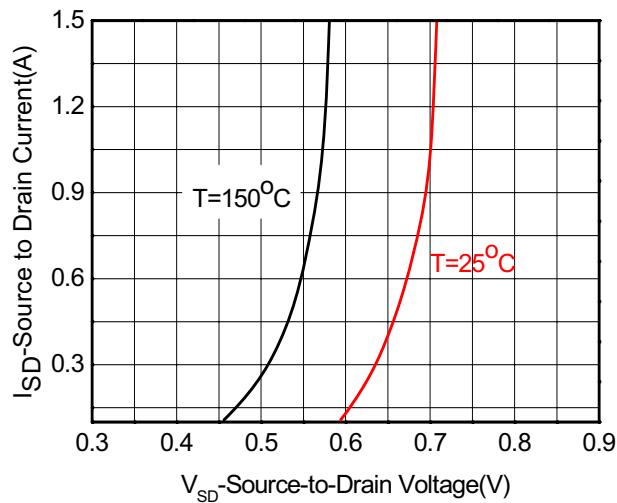
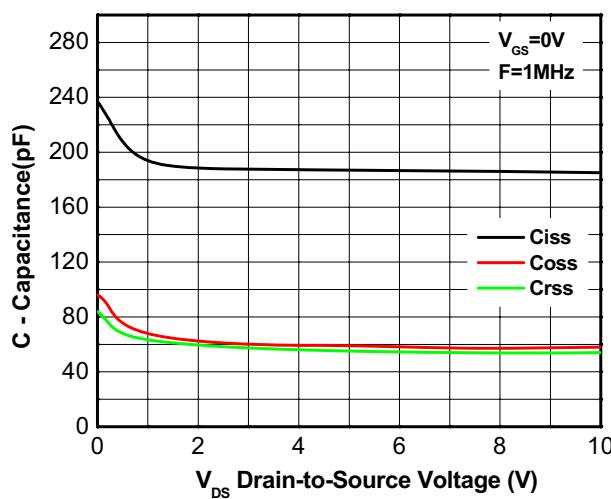
On-Resistance vs. Gate-to-Source voltage



On-Resistance vs. Junction temperature

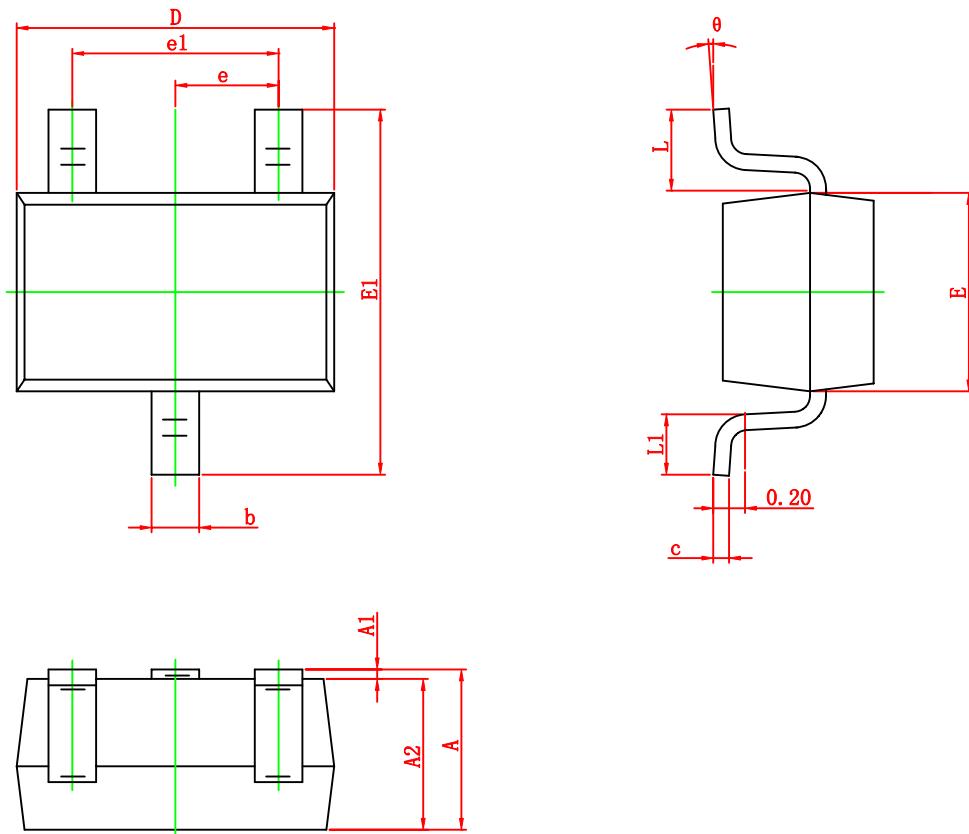


Threshold voltage vs. Temperature



Package outline dimensions

SOT-323



Symbol	Dimensions in millimeter		
	Min.	Typ.	Max.
A	0.900	1.000	1.100
A1	0.000	0.050	0.100
A2	0.900	0.950	1.000
b	0.200	0.300	0.400
c	0.080	0.115	0.150
D	2.000	2.100	2.200
E	1.150	1.250	1.350
E1	2.150	2.300	2.450
e	0.650TYP		
e1	1.200	1.300	1.400
L	0.525REF		
L1	0.260		0.460
θ	0°		8°